PATENT

TATES PATENT AND TRADEMARK OFFICE

Donald Danielson et al. Applicant:

Examiner:

Terrence M Mackey

Serial No.:

Assignee:

10/003240

Group Art Unit:

1765

Filed:

October 26, 2001

Docket:

884.614US1

Title:

ETCHANT FORMULATION FOR SELECTIVELY REMOVING THIN FILMS

IN THE PRESENCE OF COPPER, TIN, AND LEAD

Intel Corporation

Customer No.:

21186

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(c)(2), Applicants have included the fee of \$180.00 as set forth in 37 C.F.R. §1.17(p). Please charge any additional fees or credit any overpayment to Deposit Account No. 19-0743.

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Page 2 Dkt: 884.614US1 (INTEL)

Title: ETCHANT FORMULATION FOR SELECTIVELY REMOVING THIN FILMS IN THE PRESENCE OF COPPER, TIN, AND LEAD

Assignee: Intel Corporation

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

DONALD DANIELSON ET AL.

By their Representatives,

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Date Que 25, 2003 By Onn M. McCrackin

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this day of August, 2003.

Signature Louis Lel

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ad to respond to a collection of information unless it contains a valid OMB control number. Substitute for form 1449A/PTO Complete if Known INFORMATION DISCLOSURE 10/003240 **Application Number** STATEMENT BY APPLICANT October 26, 2001 **Filing Date** Danielson, Donald **First Named Inventor** 1765 **Group Art Unit** Mackey, Terrence **Examiner Name** Sheet 1 of Fr Attorney Docket No: 884.614US1

US PATENT DOCUMENTS									
Examiner Initial *	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	Filing Date If Appropriate			

FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	Class	Subclass	T²

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		LIPETZKY, PETE, "Refractory Metals: A Primer", <u>Journal of Metals</u> , The Metallurgical Society, (March 2002), 47-49	